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**CONFIRMATION NO. 4614** 

SERIAL NUMBEI 10/734,419	FILING OR 371(c) DATE 12/11/2003 RULE	CLASS 257	GROUP ART 2815	UNIT	ATTORNEY DOCKET NO. MI22-2463			
John T. Moore, Boise, ID; Scott Jeffrey DeBoer, Boise, ID; Mark Fischer, Boise, ID; J. Brett Rolfson, Boise, ID; Annette L. Martin, Boise, ID; Ardavan Niroomand, Boise, ID; This application is a CON of 09/995,372 11/26/2001 PAT 6,693,345 which is a CON of 09/724,749 11/27/2000 PAT 6,417,559 which is a DIV of 09/457,093 12/07/1999 PAT 6,303,139 which is a CIP of 09/057,155 04/07/1998 PAT 6,300,253 and is a CIP of 09/295,642 04/20/1999 PAT 6,297,171 which is a CON of 08/567,090 12/04/1995 PAT 5,926,739  FOREIGN APPLICATIONS  FOREIGN FILING LICENSE GRANTED  **O3/22/2004*								
met Verified and	ons yes one of the last af Met	STATE OR COUNTRY	SHEETS DRAWING 6	TÖT/ CLAII 14	MS	INDEPENDENT CLAIMS 3		
<b>ADDRESS</b> 021567								
TITLE Semiconductor wafer assemblies comprising photoresist over silicon nitride materials								
RECEIVED N	o to charge/cr	S: Authority has been given in Paper to charge/credit DEPOSIT ACCOUNT for following:			All Fees  1.16 Fees (Filling)  1.17 Fees (Processing Ext. of time)  1.18 Fees (Issue)  Other  Credit			